

# Oak 4-20

## V1.3.001

# PCB Production Instructions

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## 1. Overview, Statistics

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### 1.1. PCB

PCB type	rigid
Insulator material	FR4
Board Size Extents	84 X 12 mm (final size)
Layer Count	2
Board thickness	1.6mm
Copper thickness	35µm
Hole Count	67
Solder mask	on both sides
Silkscreen	no
Surface	HAL Pb-free

### 1.2. Statistics

Through Holes	67
Minimum line width	0.15mm
Smallest drill diameter	0.3mm
Smallest annular ring	0.15mm
Minimum spacing	0.15mm

### 1.3. Assembly

Assembly sides:	SMD and THT components on top side
SMD component count	32
THT component count	3



## 2. Layer Stackup

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### 2.1. Sequence of the Gerber Files

Please stack the layers in the order given below:

File name	Description	Format
SoldermaskTop.gdo	<i>Solder mask (component side)</i>	RS274-X
EtchLayer1Top.gdo	top layer / component side	
EtchLayer2Bottom.gdo	bottom layer / solder side	RS274-X
SoldermaskBottom.gdo	<i>Solder mask (solder side)</i>	

### 2.2. Additional Files

SolderPasteTop.gdo	Solder Paste (component side)	RS274-X
Mechanics.gdo	Mechanical dimensions	RS274-X
ThruHoleNonPlated.ncd	Drill coordinates (plated)	NC drill
ThruHolePlated.ncd	Drill coordinates (non-plated)	NC drill
ContourPlated.ncd	Milling coordinates (non-plated)	NC drill

### 2.3. Layer thickness

The total thickness of the board must be  $1.6\text{mm} \pm 0.15\text{mm}$

### 2.4. Proposed thicknesses:

	Description	Material	Thickness
	Top Solder Mask		
1	Top Layer	Cu	35u
		Core	1530u
4	Bottom Layer	Cu	35u
	Bottom Solder Mask		
Overall thickness			1.6mm



#### Revision history

Date	Fie Name	Initial	Changes
2011-09-23	Oak 4-20_V1_3 manufacturing instructions.doc	dus	Initial release
2012-01-03	050913_Oak_4-20_V1_3_001_ PCB_Production_Instructions_2011-01-03.doc	ub	Rename File, correct "Layer thickness"

Date	Initial	Changes
2012-05-08	ub	Changed file name, introduced new Revision History (now version or date information in the file name because the file is nor under version control).

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